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# Onsemi

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# **TinyLogic ULP-A Inverter**

# NC7SP04

The NC7SP04 is a single inverter in tiny footprint packages. The device is designed to operate for  $V_{CC} = 0.9$  V to 3.6 V.

#### Features

- Designed for 0.9 V to 3.6 V  $V_{CC}$  Operation
- 2.9 ns t<sub>PD</sub> at 3.3 V (Typ)
- Inputs/Outputs Over-Voltage Tolerant up to 3.6 V
- I<sub>OFF</sub> Supports Partial Power Down Protection
- Source/Sink 2.6 mA at 3.3 V
- Available in SC−88A and MicroPak<sup>™</sup> Packages
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

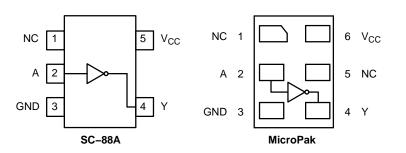


Figure 1. Pinout Diagrams (Top Views)



Figure 2. Logic Symbol

#### **PIN ASSIGNMENT**

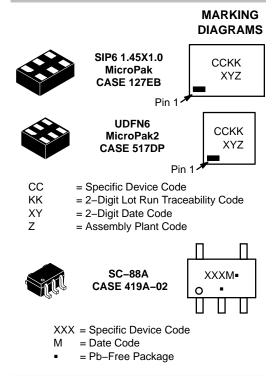
Pin	SC88A	MicroPak
1	N.C.	N.C.
2	А	А
3	GND	GND
4	Y	Y
5	V <sub>CC</sub>	N.C.
6	-	V <sub>CC</sub>

N.C. = No Connect



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#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information on page 6 of this data sheet.

#### FUNCTION TABLE

Input	Output
А	Y
L	Н
Н	L

X = Don't Care

Z = High Impedance State

#### MAXIMUM RATINGS

Symbol	Characte	eristics	Value	Unit
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +4.3	V
V <sub>IN</sub>	DC Input Voltage		-0.5 to +4.3	V
V <sub>OUT</sub>	DC Output Voltage	Active–Mode (High or Low State) Tri–State Mode (Note 1) Power–Down Mode (V <sub>CC</sub> = 0 V)	-0.5 to V <sub>CC</sub> + 0.5 -0.5 to +4.3 -0.5 to +4.3	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < GND	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < GND	-50	mA
IOUT	DC Output Source/Sink Current		±50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC Supply Current per Supply Pin or Gro	ound Pin	±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 1	0 Seconds	260	°C
TJ	Junction Temperature Under Bias		+150	°C
$\theta_{JA}$	Thermal Resistance (Note 2)	SC–88A MicroPak	377 154	°C/W
PD	Power Dissipation in Still Air	SC–88A MicroPak	332 812	mW
MSL	Moisture Sensitivity		Level 1	-
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in	_
$V_{ESD}$	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	4000 2000	V
I <sub>Latchup</sub>	Latchup Performance (Note 4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Applicable to devices with outputs that may be tri-stated.
Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow per JESD51-7.
HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

4. Tested to EIA/JÉSD78 Class II.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Min	Max	Unit
V <sub>CC</sub>	Positive DC Supply Voltage		0.9	3.6	V
V <sub>IN</sub>	DC Input Voltage		0	3.6	V
V <sub>OUT</sub>	DC Output Voltage	Active–Mode (High or Low State) Tri–State Mode (Note 1) Power–Down Mode (V <sub>CC</sub> = 0 V)	0 0 0	V <sub>CC</sub> 3.6 3.6	
T <sub>A</sub>	Operating Temperature Range		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Transition Rise and Fall Time	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	0	10	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

				Т	<sub>A</sub> = 25°	С	$T_A = -40^{\circ}C$	C to +85°C	
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Мах	Unit
VIH	High-Level Input		0.9	_	0.5	_	_	-	V
	Voltage		1.1 to 1.3	$0.65 \times V_{CC}$	-	-	0.65 x V <sub>CC</sub>	-	1
			1.4 to 1.6	$0.65 \times V_{CC}$	-	-	0.65 x V <sub>CC</sub>	-	1
		1.65 to 1.95	$0.65 \times V_{CC}$	-	_	0.65 x V <sub>CC</sub>	_	1	
			2.3 to 2.7	1.6	-	_	1.6	_	
			3.0 to 3.6	2.1	-	_	2.1	_	
VIL	Low-Level Input		0.9	-	0.5	-	-	-	V
	Voltage		1.1 to 1.3	-	-	0.35 x V <sub>CC</sub>	-	0.35 x V <sub>CC</sub>	
			1.4 to 1.6	-	-	0.35 x V <sub>CC</sub>	-	0.35 x V <sub>CC</sub>	1
			1.65 to 1.95	-	-	0.35 x V <sub>CC</sub>	-	0.35 x V <sub>CC</sub>	
			2.3 to 2.7	-	-	0.7	-	0.7	
			3.0 to 3.6	-	-	0.9	-	0.9	
V <sub>OH</sub>	High–Level Output	$V_{IN} = V_{IH} \text{ or } V_{IL}$							V
	Voltage	I <sub>OH</sub> = -20 μA	0.9	_	V <sub>CC</sub> - 0.1	-	-	-	
			1.1 to 1.3	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	
			1.4 to 1.6	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	
			1.65 to 1.95	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	
			2.3 to 2.7	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	
			3.0 to 3.6	V <sub>CC</sub> – 0.1	-	-	V <sub>CC</sub> – 0.1	-	
		I <sub>OH</sub> = -0.5 mA	1.1 to 1.3	$0.75  ext{ x V}_{CC}$	-	-	0.75 x V <sub>CC</sub>	-	
		I <sub>OH</sub> = -1 mA	1.4 to 1.6	1.07	-	-	0.99	-	
		I <sub>OH</sub> = -1.5 mA	1.65 to 1.95	1.24	-	-	1.22	-	
		I <sub>OH</sub> = -2.1 mA	2.3 to 2.7	1.95	-	-	1.87	-	
		I <sub>OH</sub> = -2.6 mA	3.0 to 3.6	2.61	-	-	2.55	-	
V <sub>OL</sub>	Low-Level Output	$V_{IN} = V_{IH} \text{ or } V_{IL}$							V
	Voltage	I <sub>OL</sub> = 20 μA	0.9	-	0.1	-	-	-	
			1.1 to 1.3	-	-	0.1	-	0.1	
			1.4 to 1.6	-	-	0.1	-	0.1	
			1.65 to 1.95	-	-	0.1	-	0.1	
			2.3 to 2.7	-	-	0.1	-	0.1	
			3.0 to 3.6	-	-	0.1	-	0.1	
	I <sub>OL</sub> = 0.5 mA	1.1 to 1.3	-	-	$0.3 \times V_{CC}$	-	$0.3 \times V_{CC}$		
	I <sub>OL</sub> = 1 mA	1.4 to 1.6	-	-	0.31	-	0.37		
	I <sub>OL</sub> = 1.5 mA	1.65 to 1.95	-	-	0.31	-	0.35		
	I <sub>OL</sub> = 2.1 mA	2.3 to 2.7	_	-	0.31	-	0.33		
	I <sub>OL</sub> = 2.6 mA	3.0 to 3.6	-	-	0.31	_	0.33		
I <sub>IN</sub>	Input Leakage Current	$V_{IN} = 0 V \text{ to } 3.6 V$	0.9 to 3.6	_	-	±0.1	-	±0.5	μA
I <sub>OFF</sub>	Power Off Leakage Current		0	-	-	0.5	-	0.5	μA
I <sub>CC</sub>	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	0.9 to 3.6	-	-	0.9	-	0.9	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

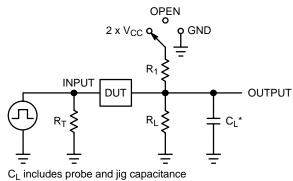
#### AC ELECTRICAL CHARACTERISTICS

				٦	Γ <sub>A</sub> = 25°0	C	T <sub>A</sub> = -40°C	C to +85°C	
Symbol	Parameter	Condition	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Мах	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay,	$R_L = 1 M\Omega$ , $C_L = 10 pF$	0.9	-	52.2	-	-	-	ns
	A to Y (Figures 3 and 4)		1.10 to 1.30	-	13.8	29.9	-	34.3	
			1.40 to 1.60	-	7.3	14.8	-	15.0	
			1.65 to 1.95	-	5.4	12.0	-	12.2	
			2.3 to 2.7	-	3.5	9.4	-	9.9	
			3.0 to 3.6	-	2.9	8.3	-	9.0	
t <sub>PLH</sub> , t <sub>PHL</sub>	HL Propagation Delay,		0.9	-	52.9	-	-	-	ns
	A to Y (Figures 3 and 4)	to Y (Figures 3 and 4)	1.10 to 1.30	-	14.1	30.4	-	37.3	
			1.40 to 1.60	-	7.5	15.5	-	16.5	
			1.65 to 1.95	-	5.5	12.6	-	13.6	
			2.3 to 2.7	-	3.6	9.9	-	10.8	
			3.0 to 3.6	-	3.0	8.7	-	9.5	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay,	$R_L = 1 M\Omega$ , $C_L = 30 pF$	0.9	-	54.8	-	-	-	ns
	A to Y (Figures 3 and 4)		1.10 to 1.30	-	15.0	31.8	-	46.3	
			1.40 to 1.60	-	8.2	17.8	-	18.2	
			1.65 to 1.95	-	6.1	14.4	-	15.9	
			2.3 to 2.7	-	3.9	11.3	-	12.8	
			3.0 to 3.6	-	3.3	9.2	-	10.7	

#### **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Test Condition	Typical (T <sub>A</sub> = 25°C)	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC} = 0 V$	2.0	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 5)	f = 10 MHz, V_{CC} = 0.9 to 3.6 V, V_IN = 0 V or V_{CC}	8.0	pF

5. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no–load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

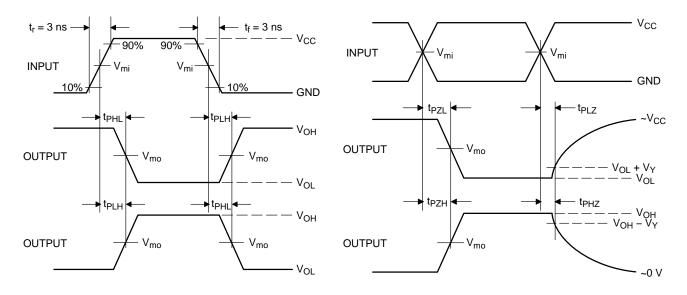


Test	Switch Position
t <sub>PLH</sub> / t <sub>PHL</sub>	Open
t <sub>PLZ</sub> / t <sub>PZL</sub>	2 x V <sub>CC</sub>
t <sub>PHZ</sub> / t <sub>PZH</sub>	GND

 $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega$ )

f = 1 MHz

Figure	3.	Test	Circ	uit
--------	----	------	------	-----



V <sub>CC</sub> , V	V <sub>mi</sub> , V	V <sub>mo</sub> , V	V <sub>Y</sub> , V
0.9	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.1
1.1 to 1.3	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.1
1.4 to 1.6	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.1
1.65 to 1.95	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.15
2.3 to 2.7	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	0.15
3.0 to 3.6	1.5	1.5	0.3

Figure 4. Switching Waveforms

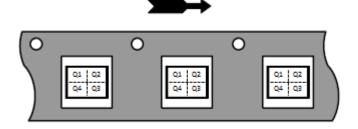
#### **ORDERING INFORMATION**

Device	Package	Marking	Pin 1 Orientation (See below)	Shipping <sup>†</sup>
NC7SP04P5X	SC-88A	P04	Q4	3000 / Tape & Reel
NC7SP04L6X	MicroPak	J6	Q4	5000 / Tape & Reel
NC7SP04FHX	MicroPak2	J6	Q4	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Pin 1 Orientation in Tape and Reel

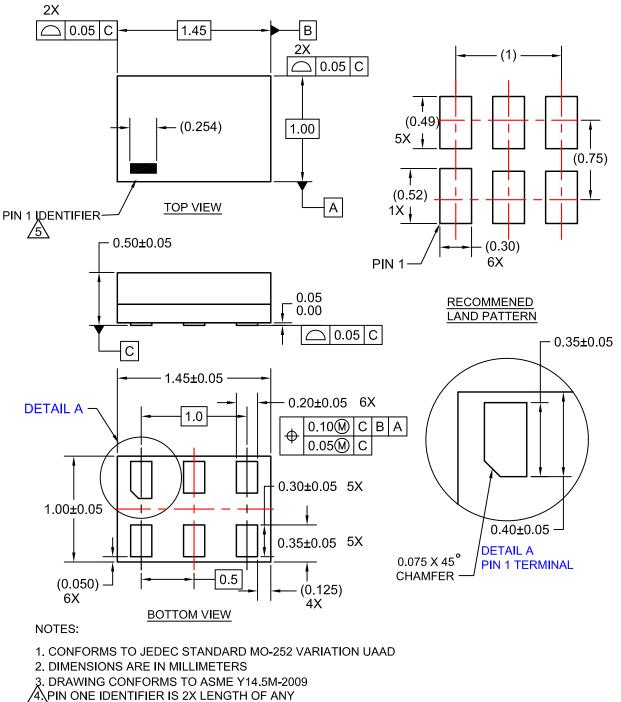
#### **Direction of Feed**



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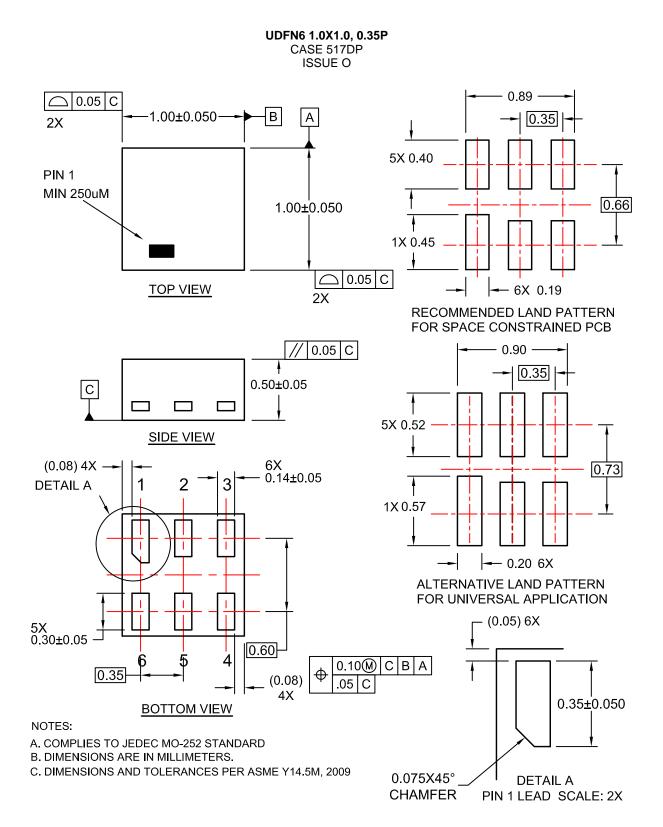
#### PACKAGE DIMENSIONS

SIP6 1.45X1.0 CASE 127EB ISSUE O



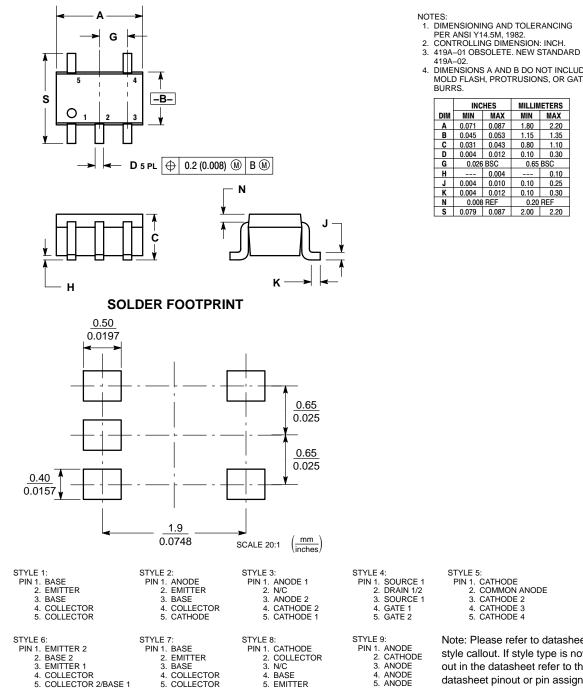
OTHER LINE IN THE MARK CODE LAYOUT.

#### PACKAGE DIMENSIONS



#### PACKAGE DIMENSIONS

SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE L



419A-02.
DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
С	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026	BSC	0.65 BSC	
Н		0.004		0.10
J	0.004	0.010	0.10	0.25
К	0.004	0.012	0.10	0.30
Ν	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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